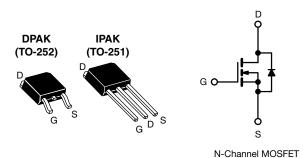


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Power MOSFET



PRODUCT SUMMARY						
V _{DS} (V)	60	60				
$R_{DS(on)}(\Omega)$	V _{GS} = 10 V	V _{GS} = 10 V 0.10				
Q _g max. (nC)	25	25				
Q _{gs} (nC)	5.8	5.8				
Q _{gd} (nC)	11					
Configuration	Single					

FEATURES

- Dynamic dV/dt rating
- Surface-mount (IRFR024, SiHFR024)
- Straight lead (IRFU024, SiHFU024)
- Available in tape and reel
- Fast switching
- Ease of paralleling
- Simple drive requirements
- · Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION						
PACKAGE	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)	
Lead (Pb)-free and halogen-free	SiHFR024-GE3	SiHFR024TR-GE3	SiHFR024TRL-GE3	IRFR024TRPbF-BE3 ^{ab}	SiHFU024-GE3	
Lead (Pb)-free	IRFR024PbF	IRFR024TRPbFa	IRFR024TRLPbF	IRFR024TRRPbF a	IRFU024PbF	

Notes

- a. See device orientation
- b. "-BE3" denotes alternate manufacturing location

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V_{DS}	60	V
Gate-source voltage			V_{GS}	± 20	V
Continuous dusin surrent	\/ at 10 \/	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	1	14	
Continuous drain current V_{GS} at 10 V $T_{C} = 100$			- I _D	9.0	Α
Pulsed drain current ^a			I _{DM}	56	
Linear derating factor				0.33	W/°C
Linear derating factor (PCB mount) e				0.020	VV/ C
Single pulse avalanche energy b			E _{AS}	91	mJ
Maximum power dissipation	T _C =	25 °C	D	42	14/
Maximum power dissipation (PCB mount) ^e T _A = 25 °C			P_{D}	2.5	W
Peak diode recovery dV/dt ^c			dV/dt	5.5	V/ns
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
oldering recommendations (peak temperature) d for 10 s			_	260	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 541 μ H, R_g = 25 Ω , I_{AS} = 14 A (see fig. 12) c. I_{SD} ≤ 17 A, dI/dt ≤ 110 A/ μ s, V_{DD} ≤ V_{DS} , T_J ≤ 150 °C
- d. 1.6 mm from case
- When mounted on 1" square PCB (FR-4 or G-10 material)

IRFR024, IRFU024, SiHFR024, SiHFU024

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R_{thJA}	-	ı	110	
Maximum junction-to-ambient (PCB mount) ^a R _{thJA} 50 °C/\		°C/W			
Maximum junction-to-case (drain)	R _{thJC}	=	=	3.0	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.073	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
7	,	V _{DS} :	= 60 V, V _{GS} = 0 V	-	-	25	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 48 \text{ V}$, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 8.4 A ^b	-	-	0.10	Ω
Forward transconductance	9 _{fs}	V _{DS} =	25 V, I _D = 8.4 A ^b	6.2	-	-	S
Dynamic		-					
Input capacitance	C _{iss}		$V_{GS} = 0 V$	-	640	-	
Output capacitance	C _{oss}	1	$V_{DS} = 25 \text{ V},$	-	360	-	pF
Reverse transfer capacitance	C _{rss}	f = 1.	.0 MHz, see fig. 5	-	79	-	1
Total gate charge	Qg			-	-	25	
Gate-source charge	Q _{qs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 17 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 b		-	5.8	nC
Gate-drain charge	Q _{qd}	See lig. 6 and 13 -		-	-	11	1
Turn-on delay time	t _{d(on)}	V_{DD} = 30 V, I_{D} = 17A, R_{G} = 18 Ω , R_{D} = 1.7 Ω , see fig. 10 $^{\rm b}$		-	13	-	ns
Rise time	t _r			-	58	-	
Turn-off delay time	t _{d(off)}			-	25	-	
Fall time	t _f			-	42	-	
Internal drain inductance	L _D	Between lead,		-	4.5	-	
Internal source inductance	L _S	6 mm (0.25") from package and center of die contact		-	7.5	-	nH
Drain-source body diode characteristic	S						
Continuous source-drain diode current	Is	MOSFET sym showing the	bol	-	-	14	
Pulsed diode forward current ^a	I _{SM}	integral reverse p - n junction diode		-	-	56	А
Body diode voltage	V _{SD}	T _J = 25 °C	, I _S = 14 A, V _{GS} = 0 V ^b	-	-	1.5	V
Body diode reverse recovery time	t _{rr}	T 05 00 1	47 A all/alt 400 A/b	-	88	180	ns
Body diode reverse recovery charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = 17 \text{A}, dI/dt = 100 \text{A/}\mu\text{s}^{\text{b}}$		-	0.29	0.64	μC
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

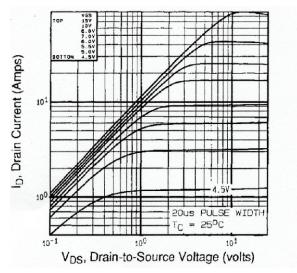


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

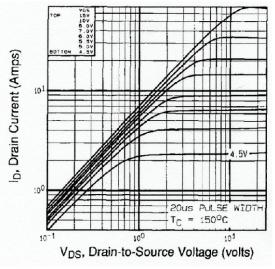


Fig. 1 - Typical Output Characteristics, $T_C = 150$ °C

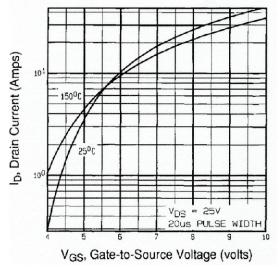


Fig. 2 - Typical Transfer Characteristics

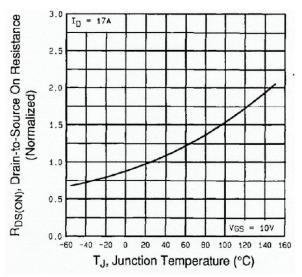


Fig. 3 - Normalized On-Resistance vs. Temperature



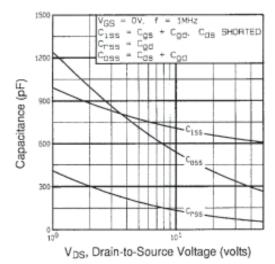


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage

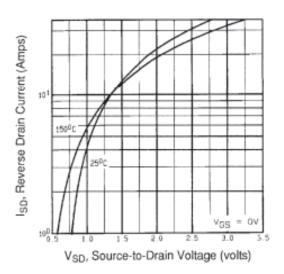


Fig. 6 - Typical Source-Drain Diode Forward Voltage

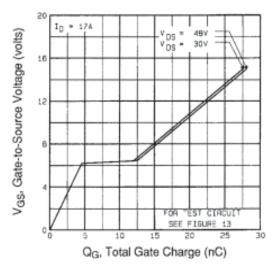


Fig. 5 - Typical Gate Charge vs. Gate-to-Source Voltage

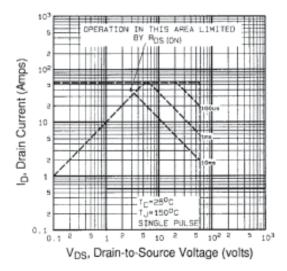


Fig. 7 - Maximum Safe Operating Area

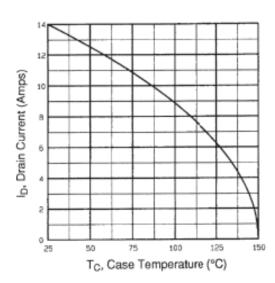


Fig. 8 - Maximum Drain Current vs. Case Temperature

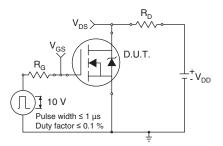


Fig. 10a - Switching Time Test Circuit

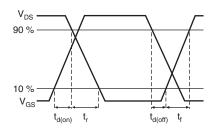


Fig. 10b - Switching Time Waveforms

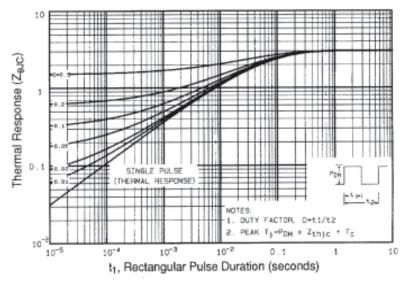


Fig. 9 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

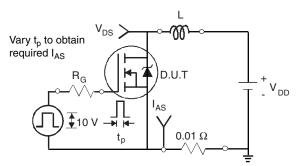


Fig. 12a - Unclamped Inductive Test Circuit

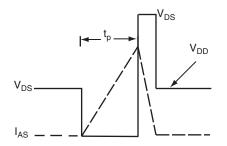


Fig. 12b - Unclamped Inductive Waveforms

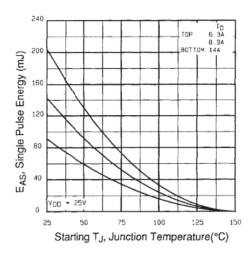


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

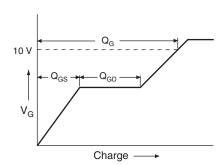


Fig. 13a - Basic Gate Charge Waveform

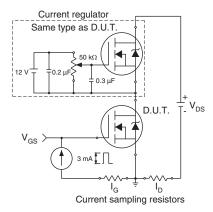
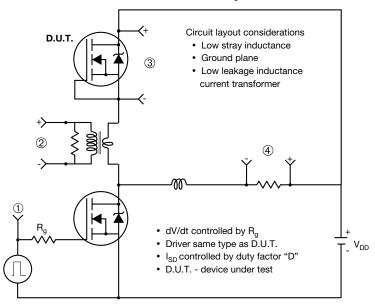


Fig. 13b - Gate Charge Test Circuit

Peak Diode Recovery dV/dt Test Circuit



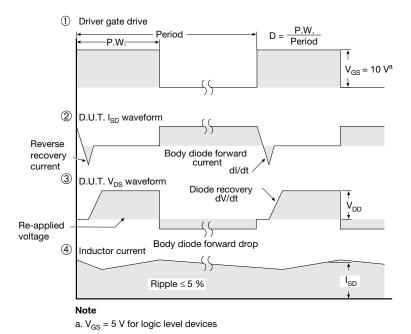


Fig. 10 - For N-Channel

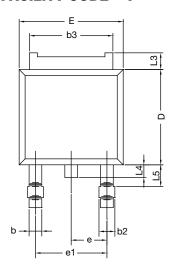
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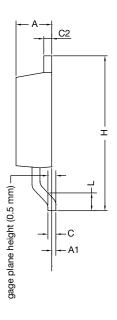


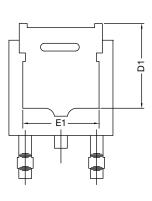
TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y

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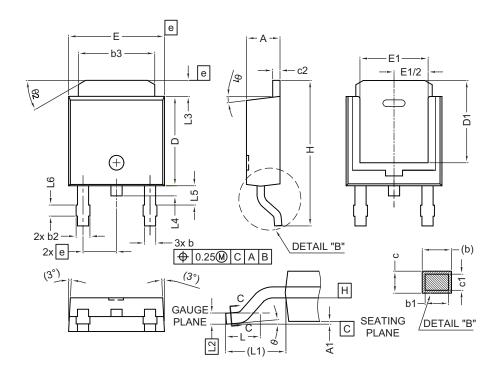
	MILLIMETERS			
DIM.	MIN.	MAX.		
А	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
Е	6.35	6.73		
E1	4.32	=		
Н	9.40	10.41		
е	2.28	BSC		
e1	4.56	BSC		
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01	1.52		

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS			
DIM.	MIN.	MAX.		
Α	2.18	2.39		
A1	-	0.13		
b	0.65	0.89		
b1	0.64	0.79		
b2	0.76	1.13		
b3	4.95	5.46		
С	0.46	0.61		
c1	0.41	0.56		
c2	0.46	0.60		
D	5.97	6.22		
D1	5.21	=		
Е	6.35	6.73		
E1	4.32	=		
е	2.29 BSC			
Н	9.94	10.34		

	MILLIMETERS			
DIM.	MIN.	MAX.		
L	1.50	1.78		
L1	2.74	ref.		
L2	0.51	BSC		
L3	0.89	1.27		
L4	-	1.02		
L5	1.14	1.49		
L6	0.65	0.85		
θ	0°	10°		
θ1	0°	15°		
θ2	25°	35°		

Notes

- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- · Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019

DWG: 5347



TO-251AA (HIGH VOLTAGE)



Section B - B and C - C

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	5.21	-	0.205	-
Е	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
е	2.29 BSC		2.29 BSC	
L	8.89	9.65	0.350	0.380
L1	1.91	2.29	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.14	1.52	0.045	0.060
θ1	0'	15'	0'	15'
θ2	25'	35'	25'	35'

ECN: S-82111-Rev. A, 15-Sep-08

DWG: 5968

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.

Document Number: 91362 Revision: 15-Sep-08



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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